

Quarterly Reliability Monitoring Results

Quarters: Q1/2021 to Q4/2021

Based on structural similarity

| Supplier | | User Part Number | | | | |
|---------------------------|---|------------------------------------|-----------|------------|-----------|--|
| Nexperia B.V. | | BZX884S-C5V1 | | | | |
| Name of Laboratory | | Part Description | | | | |
| Assembly reliability labs | | Nexperia DHAM Zener MCD package | | | | |
| Test | Test Conditions | Duration | # Lots | # Quantity | # Rejects | |
| # 1 | TEST Pre- and Post-Stress Electrical Test Tamb = 25 °C | N/A | see below | all parts | see below | |
| # 2 | PC Preconditioning JESD22-A113 Bake Tamb = 125 °C Soak Tamb = 85 °C, RH = 85% Reflow soldering | 24 hours 168 hours 3 cycles | 113 | 9040 | 0 | |
| # 5 | HTRB High Temperature Reverse Bias MIL-STD-750-1 M1038 Method A Tj = Tjmax, Vr = 100% of max. datasheet reverse voltage | 1000 hours | 138 | 11040 | 0 | |
| # 5c | SSOP Steady State Operational MIL-STD-750-1 M1038 Method B Tj = Tjmax, Iz = 100% of max. datasheet reverse current | 1000 hours | 20 | 1600 | 0 | |
| # 7 | TC Temperature Cycling JESD22-A104 -65 °C to Tjmax, not to exceed 150°C | 1000 cycles | 28 | 2240 | 0 | |
| # 8 | AC Autoclave JESD22-A102 Tamb = 121 °C, RH = 100 % Pressure = 205 kPa (29.7 psia) | 96 hours | 28 | 2240 | 0 | |
| # 9 | H3TRB High Humidity High Temperature Reverse Bias JESD22-A101 Tamb = 85 °C, RH = 85%, VR = 80 % of rated reverse voltage ^[1] | 1000 hours | 28 | 2240 | 0 | |
| # 10 | IOL Intermittent Operating Life MIL-STD-750 Method 1037 ton = toff, devices powered to insure ΔTj = 100 °C for 15000 cycles | 1000 hours | 29 | 2320 | 0 | |
| # 20 | RSH Resistance to Solder Heat JESD22-A111 260 °C ± 5 °C | 10 s | n.a. | n.a. | n.a. | |
| # 21 | SD Solderability J-STD-002 | | 63 | 630 | 0 | |

[1] The maximum applied voltage is limited by test chamber set up and does not exceed 115V.

Calculation of FIT and MTF

Test considered for FIT calculation: High Temperature Reverse Bias (HTRB, Test # 5)

Confidence level 60%, derated to 55 °C, activation energy 0.7 eV, test time 168 to 1000 hours

| Wafer Fab | Technology | Quantity | Rejects | Failure Rate (FIT) | MTTF (hrs) |
|------------------|------------|----------|---------|--------------------|------------|
| Nexperia DHAM | Zener | 11040 | 0 | 0.38 | 2.60E+09 |

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